



Docket No.
P-US024-A-MF

Declaration For Patent Application

English Language Declaration

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name,

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled

the specification of which

(check one)

☐ is attached hereto.

☒ was filed on November 26, 2003 as United States Application No. or PCT International Application Number 10/724,515 and was amended on _____

(if applicable)

I hereby state that I have reviewed and understand the contents of the above identified specification, including the claims, as amended by any amendment referred to above.

I acknowledge the duty to disclose information which is material to patentability as defined in 37 CFR 1.56, including for continuation-in-part applications, material information which became available between the filing date of the prior applications and the national or PCT international filing date of the continuation-in-part application.

I hereby claim foreign priority benefits under 35 U.S.C. 119(a)-(d) or (f), or 365(b) of any foreign application(s) for patent, inventor's or plant breeder's rights certificate(s), or 365(a) of any PCT International application which designated at least one country other than the United States of America, listed below and have also identified below, by checking the box, any foreign application for patent or inventor's or plant breeder's rights certificate(s), or any PCT international application having a filing date before that of the application on which priority is claimed.

Prior Foreign Application(s)			Priority Not Claimed
_____ (Number)	_____ (Country)	_____ (Day/Month/Year Filed)	<input type="checkbox"/>
_____ (Number)	_____ (Country)	_____ (Day/Month/Year Filed)	<input type="checkbox"/>
_____ (Number)	_____ (Country)	_____ (Day/Month/Year Filed)	<input type="checkbox"/>

Form PTO-SB-01 (6-95) (Modified)

November 26, 2002

(Filing Date)

(Filing Date)

(Filing Date)

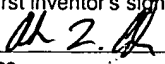
Form PTO-SB-01 (6-95) (Modified)

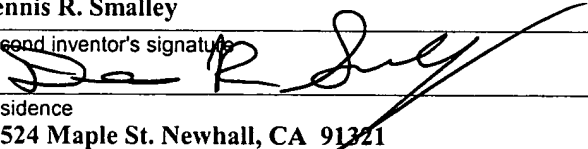
(Status)
(patented, pending, abandoned)

(Status)
(patented, pending, abandoned)

(Status)
(patented, pending, abandoned)

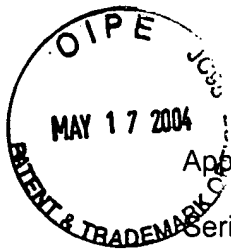
Form PTO-SB-01 (6-95) (Modified)

Full name of sole or first inventor Adam L. Cohen	
Sole or first inventor's signature 	Date 2/29/04
Residence 9537 Kirkside Rd. Los Angeles, CA 90035	
Citizenship United States	
Post Office Address	

Full name of second inventor, if any Dennis R. Smalley	
Second inventor's signature 	Date 2/29/04
Residence 23524 Maple St. Newhall, CA 91321	
Citizenship United States	
Post Office Address	

Full name of third inventor, if any	
Third inventor's signature	Date
Residence	
Citizenship	
Post Office Address	

Full name of fourth inventor, if any	
Fourth inventor's signature	Date
Residence	
Citizenship	
Post Office Address	



Applicant: Microfabrica Inc.

Docket No: P-US024-A-MF

Serial No: 10/724,515

Filing Date: November 26, 2003

Inventor: Cohen, et al.

Title: Method for Electrochemically Forming Structures Including Non-Parallel Mating of Contact Masks and Substrates

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313

February 25, 2004

POWER OF ATTORNEY & REVOCATION

Dear Sir:

I hereby revoke all previous powers of attorney given in the above-identified application.

I hereby appoint Dennis R. Smalley having USPTO Registration No. 35,364 as agent to prosecute the application identified above, and to transact all business concerning this application.

All communications concerning the above-noted application should be directed to Dennis R. Smalley, Microfabrica Inc., 1103 W. Isabel St., Burbank, CA 91506, USA.

Signature of Assignee Representative:

Microfabrica Inc.

Adam L. Cohen
Chairman & EVP Technology

February 25, 2004

Date